

# CNA1006N

## Photo Interrupter

For contactless SW and object detection

### ■ Overview

CNA1006N is a transmissive photosensor in which a high efficiency GaAs infrared light emitting diode is used as the light emitting element, and a high sensitivity phototransistor is used as the light detecting element. The two elements are arranged so as to face each other, and objects passing between them are detected.

### ■ Features

- Highly precise position detection: 0.3 mm
- Gap width: 3 mm
- The type directly attached to PCB (with a positioning pins)

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Input (Light emitting diode)	Power dissipation <sup>*1</sup>	P <sub>D</sub>	75
	Forward current	I <sub>F</sub>	50
	Reverse voltage	V <sub>R</sub>	3
Output (Photo transistor)	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	30
	Emitter-collector voltage (Base open)	V <sub>ECO</sub>	5
	Collector current	I <sub>C</sub>	20
	Collector power dissipation <sup>*2</sup>	P <sub>C</sub>	100
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C
Storage temperature	T <sub>stg</sub>	-40 to +100	°C

Note) \*1: Input power derating ratio is 1.0 mW/°C at  $T_a \geq 25^\circ\text{C}$ .

\*2: Output power derating ratio is 1.33 mW/°C at  $T_a \geq 25^\circ\text{C}$ .

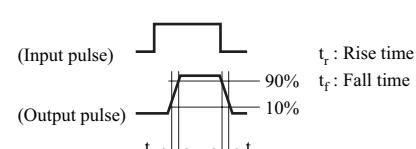
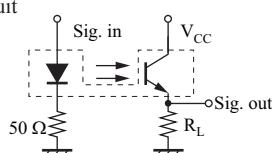
### ■ Electrical-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

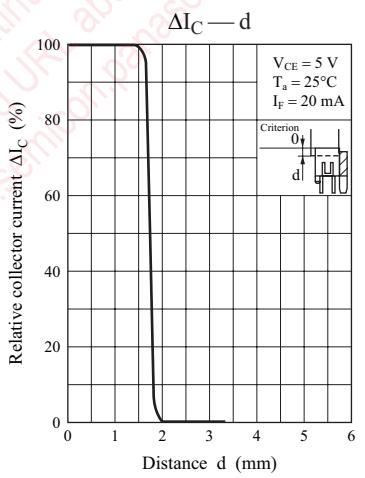
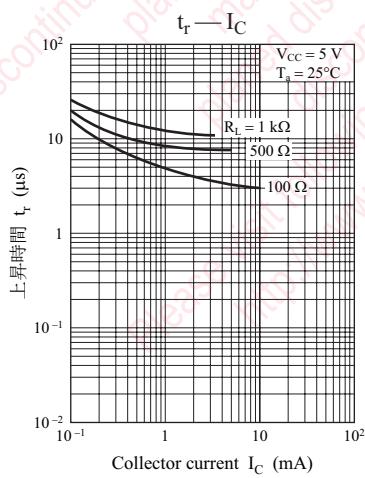
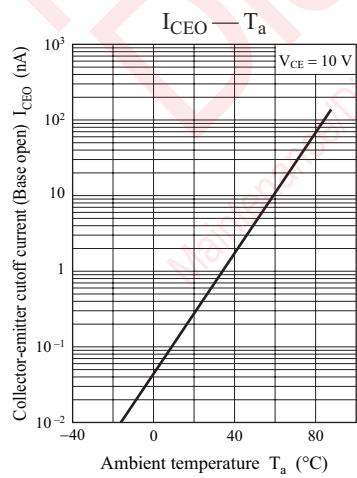
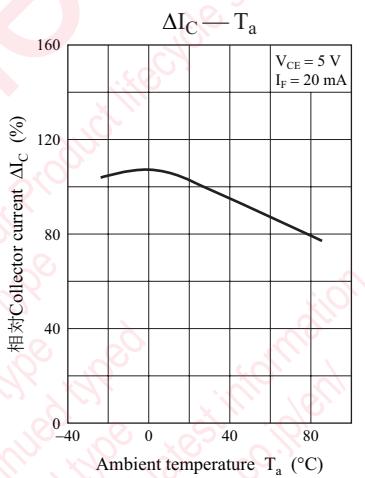
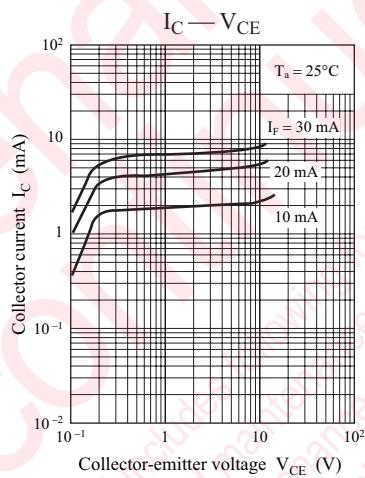
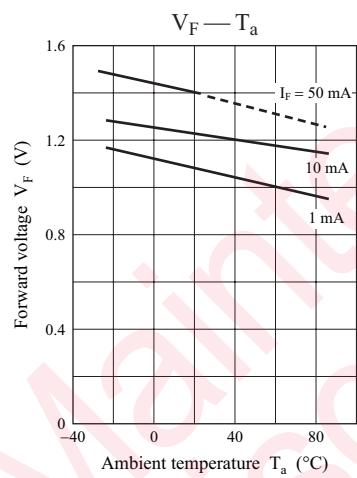
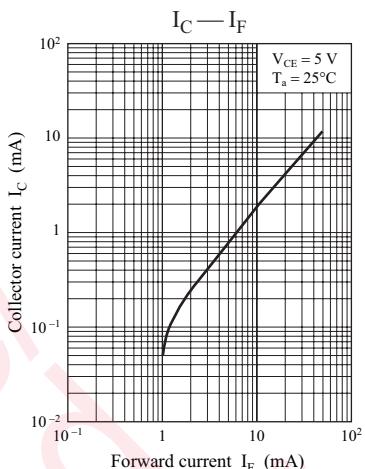
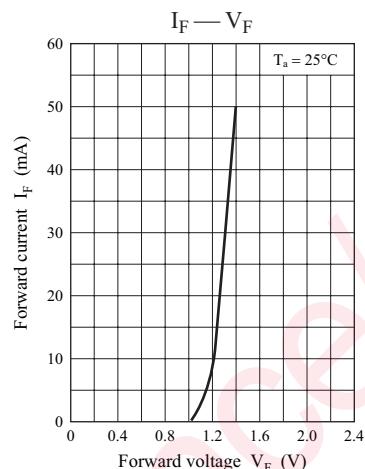
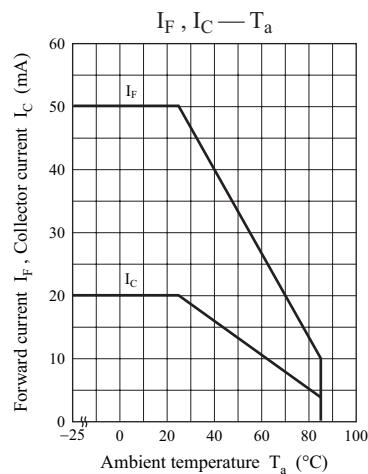
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input characteristics	Reverse current	I <sub>R</sub> $V_R = 3\text{ V}$			10	μA
	Forward voltage	V <sub>F</sub> $I_F = 20\text{ mA}$		1.25	1.4	V
Output characteristics	Collector-emitter cutoff current (Base open)	I <sub>CEO</sub> $V_{CE} = 10\text{ V}$		10	200	nA
	Collector current	I <sub>C</sub> $V_{CE} = 5\text{ V}, I_F = 20\text{ mA}$	0.7		14.0	mA
Transfer characteristics	Collector-emitter saturation voltage	V <sub>CE(sat)</sub> $I_F = 40\text{ mA}, I_C = 1\text{ mA}$			0.4	V
	Rise time <sup>*</sup>	t <sub>r</sub> $V_{CC} = 5\text{ V}, I_C = 1\text{ mA}, R_L = 100\text{ Ω}$		5.0		μs
	Fall time <sup>*</sup>	t <sub>f</sub> $V_{CC} = 5\text{ V}, I_C = 1\text{ mA}, R_L = 100\text{ Ω}$		5.0		μs

Note) 1. Input and output are practiced by electricity.

2. This device is designed by disregarding radiation.

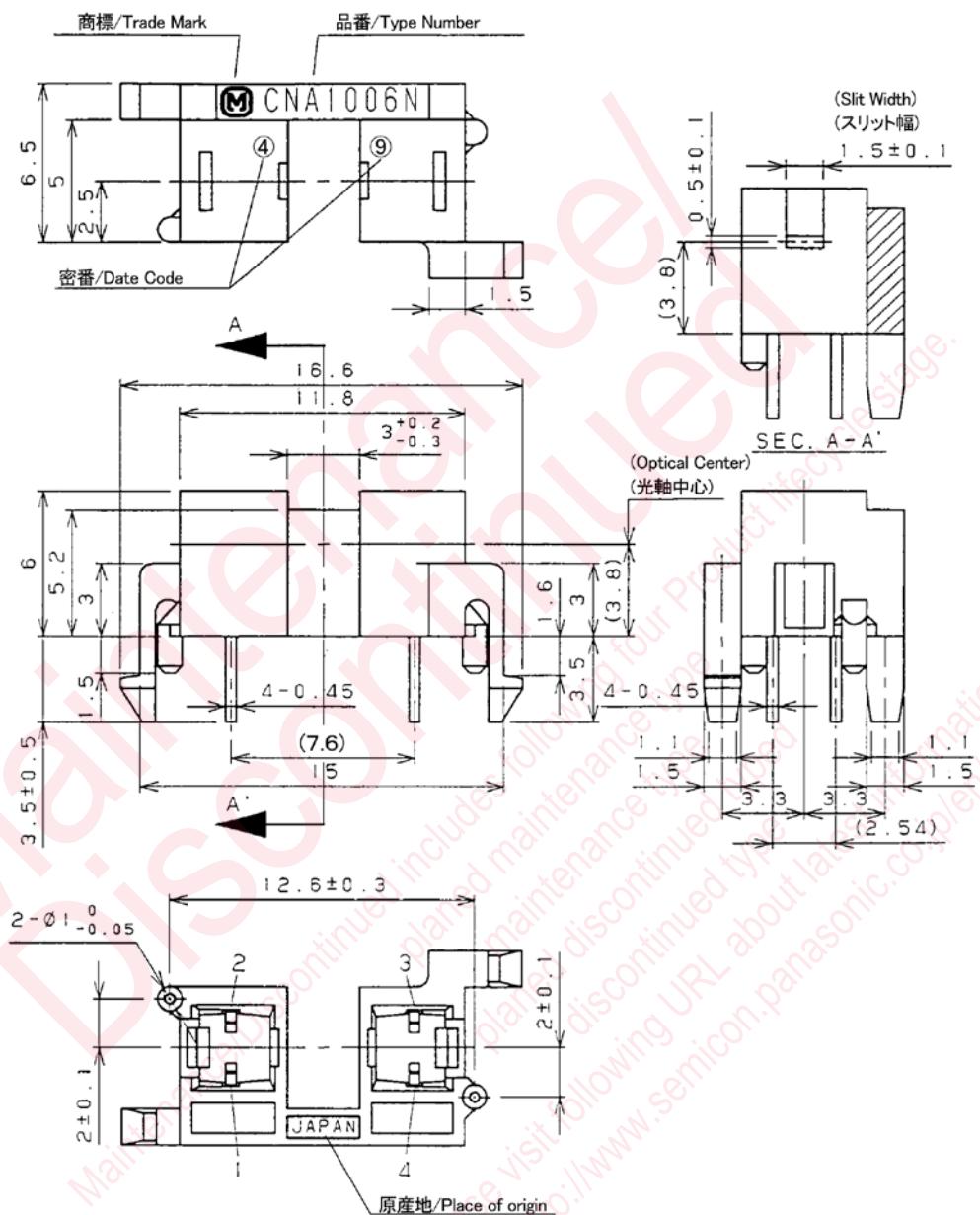
3. \*: Switching time measurement circuit





## ■ Package (Unit: mm)

## LSSSIR4S0006



(注 1)(Note1)指示無き寸法公差 : ±0.3 / Not appointment tolerance : ±0.3

(注 2)(Note2)嵌合強度 : 2N 以上(静止荷重) / Fitting strength : 2 N Min. (Static load)

(注 3) マークは、目視又は顕微鏡に於いて解読できる事

(Note3)What a mark sees an attention and can decode in a microscope.

## • Pin name

1: Anode

2: Cathode

3: Collector

4: Emitter

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